

Technical Data Sheet

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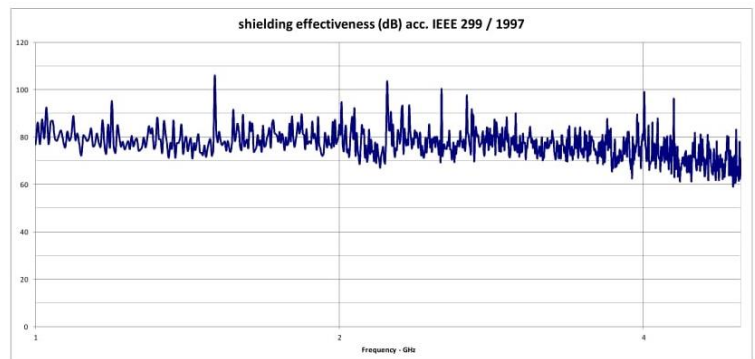
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Purpose	Conductive woven fabric for general use (outside skin for EMI/RFI fabric over foam gaskets, shielding material for laminated flat I/O shielding panels, EMI/RFI cable shielding)
Description	Tin copper silver plated polyamide ripstop fabric
Surface resistivity	< 0.02 Ohms/□
Shielding effectiveness	Average up to 80 db from 300Mhz to 10Ghz
Temperature range	-30°C to 90°C
Total thickness	0.110mm ± 10%
Weight	77g/m ² ± 10%
Roll width	130cm ± 3%
Roll length	max 200m

Compliance and Certification

RoHS
REACH



Alterations Reserved
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